SDAS278 - JANUARY 1995

- Bidirectional Bus Transceivers in High-Density 20-Pin Packages
- True Logic
- 3-State Outputs
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

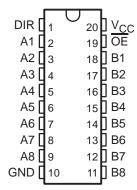
### description

These octal bus transceivers are designed for asynchronous two-way communication between data buses. These devices transmit data from the A bus to the B bus or from the B bus to the A bus, depending on the level at the direction-control (DIR) input. The output-enable  $(\overline{OE})$  input can be used to disable the device so that the buses are effectively isolated.

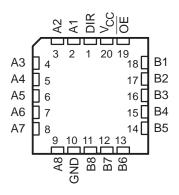
The -1 version of the SN74ALS645A is identical to the standard version, except that the recommended maximum  $I_{OL}$  is increased to 48 mA. There is no -1 version of the SN54ALS645A.

The SN54ALS645A and SN54AS645 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS645A and SN74AS645 are characterized for operation from 0°C to 70°C.

SN54ALS645A, SN54AS645 . . . J PACKAGE SN74ALS645A, SN74AS645 . . . DW OR N PACKAGE (TOP VIEW)



SN54ALS645A, SN54AS645 . . . FK PACKAGE (TOP VIEW)



#### **FUNCTION TABLE**

INP	UTS	ODED ATION
OE	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
Н	X	Isolation

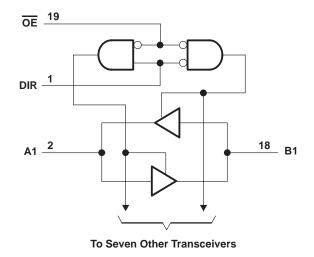
## SN54ALS645A, SN54AS645, SN74ALS645A, SN74AS645 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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### logic symbol†

#### OE DIR 3 EN1 [BA] 3 EN2 [AB] 18 В1 $\triangleright$ 2 ▽ 17 B2 16 **A3 B3** 15 **B**4 Α4 14 Α5 **B5** 13 **B6** A6 12 Α7 **B7** 11 **A8 B8**

### logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Input voltage, V <sub>I</sub> : All inputs	
I/O ports	5.5 V
Operating free-air temperature range, TA: SN54A	LS645A –55°C to 125°C
SN74A	LS645A 0°C to 70°C
Storage temperature range	65°C to 150°C

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions

		SN54ALS645A			SN7	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNII
Vсс	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V <sub>IL</sub>	Low-level input voltage			0.7			0.8	V
IOH	High-level output current			-12			-15	mA
lo.	Low lovel output ourrent			12			24	mA
lOL	Low-level output current						48§	IIIA
TA	Operating free-air temperature	-55		125	0		70	°C

<sup>§</sup> Applies only to the -1 version and only if V<sub>CC</sub> is between 4.75 V and 5.25 V



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## SN54ALS645A, SN54AS645, SN74ALS645A, SN74AS645 **OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS**

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### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CON	IDITIONS	SN5	4ALS64	5A	SN7	UNIT		
		TEST CON	IDITIONS	MIN	TYP <sup>†</sup>	MAX	MIN	TYP	MAX	UNII
٧ıĸ		$V_{CC} = 4.5 \text{ V},$	$I_{I} = -18 \text{ mA}$			-1.5			-1.5	V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V <sub>CC</sub> -2	)		V <sub>CC</sub> -2	2		
\/a			$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2		V
VOH		V <sub>CC</sub> = 4.5 V	$I_{OH} = -12 \text{ mA}$	2						V
			$I_{OH} = -15 \text{ mA}$				2			
V <sub>OL</sub>			I <sub>OL</sub> = 12 mA		0.25	0.4		0.25	0.4	
		V <sub>CC</sub> = 4.5 V	$I_{OL} = 24 \text{ mA}$					0.35	0.5	V
			$I_{OL} = 48 \text{ mA}^{\ddagger}$					0.35	0.5	
1.	Control inputs	V <sub>CC</sub> = 5.5 V	V <sub>I</sub> = 7 V			0.1			0.1	mA
11	A or B ports	vCC = 3.3 v	V <sub>I</sub> = 5.5 V			0.1			0.1	IIIA
	Control inputs	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			20			20	μΑ
lін	A or B ports§	VCC = 5.5 V,	V   = 2.7 V			20			20	μΑ
1	Control inputs	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 0.4 V			-0.1			-0.1	mA
IIL	A or B ports§	VCC = 5.5 V,	V  = 0.4 V		-0.1				-0.1	IIIA
Io¶		$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 2.25 V	-20		-112	-30		-112	mA
			Outputs high		30	48		30	45	
ICC		V <sub>CC</sub> = 5.5 V	Outputs low		36	60		36	55	mA
			Outputs disabled		38	63		38	58	

<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

## switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C <sub>L</sub> R1 R2	_ = 50 pF l = 500	2,	,	UNIT
			SN54AL	S645A	SN74AL		
			MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	A or B	D A	1	19	3	10	no
t <sub>PHL</sub>	AUID	B or A	1	14	3	10	ns
<sup>t</sup> PZH	ŌĒ	A D	2	30	5	20	ns
t <sub>PZL</sub>	OE	A or B	2	29	5	20	115
<sup>t</sup> PHZ	ŌĒ	A or B	2	14	2	10	ne
t <sub>PLZ</sub>	OE .	AUIB	2	30	4	15	ns

<sup>#</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



 $<sup>\</sup>ddagger$  Applies only to the -1 version and only if V<sub>CC</sub> is between 4.75 V and 5.25 V § For I/O ports, the parameters I<sub>IH</sub> and I<sub>IL</sub> include the off-state output current.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

## SN54ALS645A, SN54AS645, SN74ALS645A, SN74AS645 **OCTAL BUS TRANSCEIVERS** WITH 3-STATE OUTPUTS

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub>	7 V
Input voltage, V <sub>I</sub> : All inputs	7 V
I/O ports	5.5 V
Operating free-air temperature range, T <sub>A</sub> : SN54AS645	55°C to 125°C
SN74AS645	0°C to 70°C
Storage temperature range	-65°C to 150°C

### recommended operating conditions

		SI	N54AS64	5	SI	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V <sub>IH</sub>	High-level input voltage	2			2			V
$V_{IL}$	Low-level input voltage			0.8			0.8	V
IOH	High-level output current			-12			-15	mA
lOL	Low-level output current			48			64	mA
TA	Operating free-air temperature	-55		125	0		70	°C

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		TEOT 001	IDITIONS	SN	154AS64	15	SN	174AS64	15	UNIT
	PARAMETER	TEST CON	NDITIONS	MIN	TYP‡	MAX	MIN	TYP <sup>‡</sup>	MAX	UNII
٧ıK		V <sub>CC</sub> = 4.5 V,	$I_{I} = -18 \text{ mA}$			-1.2			-1.2	V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$	V <sub>CC</sub> -2	2		V <sub>CC</sub> -2			
\/ a			$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2		V
VOH		$V_{CC} = 4.5 \text{ V}$	$I_{OH} = -12 \text{ mA}$	2.4						V
			$I_{OH} = -15 \text{ mA}$				2.4			
VOL		V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 48 mA		0.3	0.55				V
		VCC = 4.5 V	$I_{OL} = 64 \text{ mA}$					0.35	0.55	,
1.	Control inputs	V <sub>CC</sub> = 5.5 V	V <sub>I</sub> = 7 V			0.1			0.1	mA
11	A or B ports	VCC = 5.5 V	V <sub>I</sub> = 5.5 V			0.1			0.1	IIIA
l	Control inputs	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			20			20	μА
ΙΗ	A or B ports§	VCC = 3.3 v,	V  = 2.7 V		70				70	μΑ
1	Control inputs	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 0.4 V			-0.5			-0.5	mA
ΊL	A or B ports§	VCC = 5.5 v,	V  = 0.4 V		-0.75				-0.75	IIIA
IOI		$V_{CC} = 5.5 \text{ V},$	$V_0 = 2.25 \text{ V}$	-50		-150	-50		-150	mA
	_		Outputs high		62	97		62	97	
ICC		V <sub>CC</sub> = 5.5 V	Outputs low		95	149		95	149	mA
			Outputs disabled		79	123		79	123	

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .



<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>§</sup> For I/O ports, the parameters I<sub>IH</sub> and I<sub>IL</sub> include the off-state output current.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

# SN54ALS645A, SN54AS645, SN74ALS645A, SN74AS645 **OCTAL BUS TRANSCEIVERS** WITH 3-STATE OUTPUTS SDAS278 – JANUARY 1995

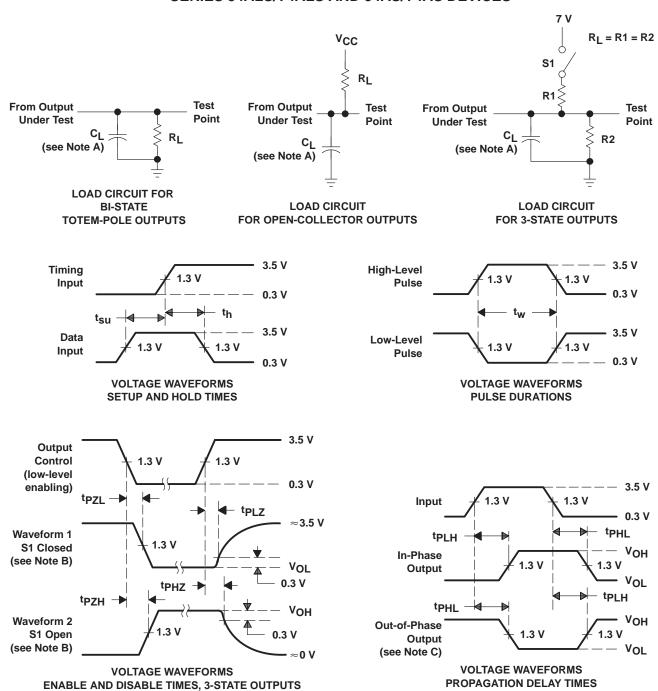
## switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C <sub>L</sub> R1 R2 T <sub>A</sub>	= 50 pF = 500 Ω = 500 Ω = MIN t	2, 2, o MAX†		UNIT
			SN54A	S645	SN74A		
			MIN	MAX	MIN	MAX	
<sup>t</sup> PLH	A or B	D A	2	11	2	9.5	ns
<sup>t</sup> PHL	AOID	B or A	2	10.5	2	9	115
<sup>t</sup> PZH	ŌĒ	A D	2	12	2	11	ns
<sup>t</sup> PZL	OE .	A or B	2	12	2	10	119
t <sub>PHZ</sub>	ŌĒ	A or B	2	8	2	7	nc
t <sub>PLZ</sub>	OE .	AUIB	2	13	2	12	ns

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

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### PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics:  $PRR \le 1$  MHz,  $t_f = t_f = 2$  ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms







28-Jul-2020

### **PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	<b>Device Marking</b> (4/5)	Samples
8403301RA	ACTIVE	CDIP	J	20	1	TBD	SNPB	N / A for Pkg Type	-55 to 125	8403301RA SNJ54ALS645AJ	Samples
8403301SA	ACTIVE	CFP	W	20	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	8403301SA SNJ54ALS645AW	Samples
SN54ALS645AJ	ACTIVE	CDIP	J	20	1	TBD	SNPB	N / A for Pkg Type	-55 to 125	SN54ALS645AJ	Sample
SN54AS645J	ACTIVE	CDIP	J	20	1	TBD	SNPB	N / A for Pkg Type	-55 to 125	SN54AS645J	Sample
SN74ALS645A-1DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS645A-1	Sample
SN74ALS645A-1DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS645A-1	Sample
SN74ALS645A-1N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS645A-1N	Sample
SN74ALS645A-1NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS645A-1	Sample
SN74ALS645ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS645A	Sample
SN74ALS645ADWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS645A	Sample
SN74ALS645AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS645AN	Sample
SN74ALS645ANSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS645A	Sample
SN74AS645N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	NIPDAU	N / A for Pkg Type	0 to 70	SN74AS645N	Sample
SNJ54ALS645AJ	ACTIVE	CDIP	J	20	1	TBD	SNPB	N / A for Pkg Type	-55 to 125	8403301RA SNJ54ALS645AJ	Sample
SNJ54ALS645AW	ACTIVE	CFP	W	20	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	8403301SA SNJ54ALS645AW	Sample
SNJ54AS645J	ACTIVE	CDIP	J	20	1	TBD	SNPB	N / A for Pkg Type	-55 to 125	SNJ54AS645J	Sample

<sup>(1)</sup> The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.





28-.lul-2020

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54ALS645A, SN54AS645, SN74ALS645A, SN74AS645:

Catalog: SN74ALS645A, SN74AS645

Military: SN54ALS645A, SN54AS645

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product



## **PACKAGE OPTION ADDENDUM**

28-Jul-2020

• Military - QML certified for Military and Defense Applications

## PACKAGE MATERIALS INFORMATION

www.ti.com 6-May-2017

### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

All differsions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS645A-1DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74ALS645A-1NSR	SO	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1
SN74ALS645ADWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74ALS645ANSR	SO	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1

www.ti.com 6-May-2017



\*All dimensions are nominal

7 III dillionorio di o richimal							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS645A-1DWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74ALS645A-1NSR	SO	NS	20	2000	367.0	367.0	45.0
SN74ALS645ADWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74ALS645ANSR	SO	NS	20	2000	367.0	367.0	45.0

### **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOIC



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



# W (R-GDFP-F20)

## CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.

  D. Index point is provided on cap for terminal identification only.

  E. Falls within Mil—Std 1835 GDFP2—F20



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